REV LETTER: F PAGE NO: 1 OF 1 PART NUMBER:

# Polymer PTC Devices

Surface mount fuses

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# LP-NSM016

# **Features**

- □ Small size of 1206
- □ Lead-free and compliant with the European Union RoHS Directive 2002/95/EC
- ☐ Fast tripping resettable circuit protection
- □ Surface mount packaging for automated assembly
- ☐ Agency Recognition: UL、CSA

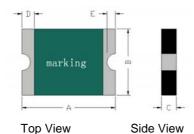




# **Product Dimensions (mm)**

Part number —	Α	В	С	D	E	— Part marking
Part number —	Max.	Max.	Max.	Min.	Min.	— Fait illarking
LP-NSM016	3.50	1.80	0.85	0.10	0.20	T

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## **Electrical Characteristics**

Dant march on	lμ	Ι <sub>Τ</sub>	$V_{max}$	I <sub>max</sub>	T <sub>trip</sub>		Pd <sub>typ</sub>	$R_{min}$	R <sub>1max</sub>
Part number	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	<b>(Ω)</b>
LP-NSM016	0.16	0.37	30	20	1.0	0.30	0.6	1.20	4.50

I<sub>H</sub>=Hold current: maximum current at which the device will not trip at 25°C still air.

I<sub>T</sub>=Trip current: minimum current at which the device will always trip at 25℃ still air.

V<sub>max</sub>=Maximum voltage device can withstand without damage at rated current.

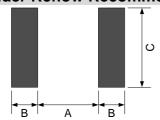
 $I_{max}$ =Maximum fault current device can withstand without damage at rated voltage.

T<sub>trip</sub>=Maximum time to trip(s) at assigned current.

Pd<sub>typ</sub>=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

 $R_{1\text{max}}$ =Maximum device resistance measured in the nontripped state 1 hour post reflow.

#### **Solder Reflow Recommendations**





Solder Pad Layouts							
Part number	Part number A B C						
_	(mm)	(mm)	(mm)				
LP-NSM016	1.80	1.00	1.80				

- \* Recommended reflow methods: IR, Vapor phase, hot air oven.
- \* Devices can be cleaned using standard industry methods and solvents.

#### Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

#### **Package Information**

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.